

LMS33460 3V Under Voltage Detector

Check for Samples: [LMS33460](#)

FEATURES

- Ultra Low Power
- 3.0V Detection
- V_{IN} Range: 0.8V to 7.0V
- Open Drain Output
- Ultra-small SC70-5 Package
- Extended Temperature Range (-40°C to 85°C)
- Ultra Low Quiescent Current ($1\mu\text{A}$ typ)

APPLICATIONS

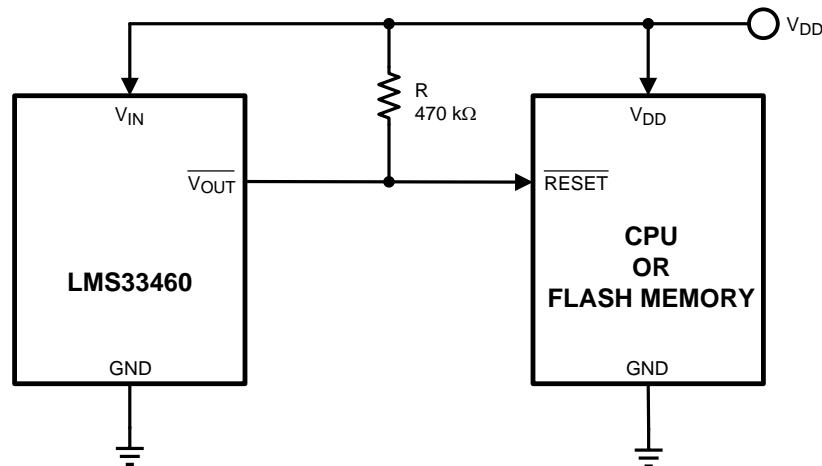
- Low Battery Voltage Detector
- Power Fail Indicator
- Processor Reset Generator
- Battery Backup Control
- Battery Operated Equipment
- Hand-held Instruments

DESCRIPTION

The LMS33460 is an under voltage detector with a 3.0V threshold and extremely low power consumption. The LMS33460 is specifically designed to accurately monitor power supplies. It is especially suited to battery powered systems where low quiescent current and small size are required. This IC generates an active output whenever the input voltage drops below 3.0 Volts.

This part uses a precision on-chip voltage reference and a comparator to measure the input voltage. Built in hysteresis helps to prevent erratic operation in the presence of noise. The UVD is available in the ultra-miniature SC70-5 package.

Typical Application



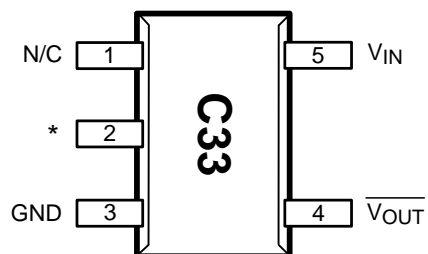
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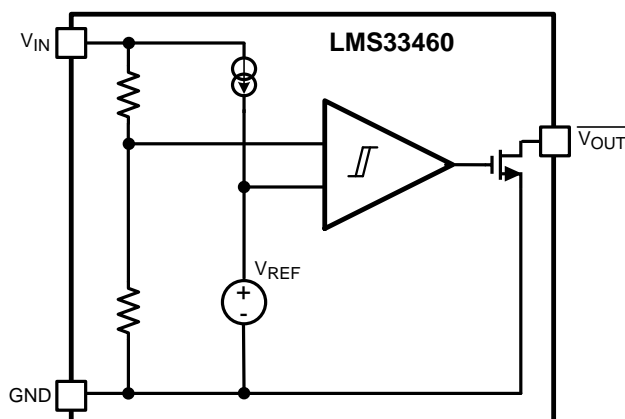
Connection Diagram



* Pin 2 is internally connected to Pin 3 (GND).
Pin 2 should be left open or connected to ground.

**Figure 1. SC70-5
Top View**

Block Diagram





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Input Voltage to GND	8.0V
Output Voltage to GND	8.0V
Output Continuous Output Current	30mA
Vapor Phase IR Convection Reflow	240°C
ESD Rating ⁽²⁾	
Human Body Model	2500V
Machine Model	200V
T _{JMAX} ⁽³⁾	150°C
θ _{JA} ⁽³⁾	478°C/W

- (1) Absolute maximum ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its rated operating conditions.
 (2) Human Body Model (HBM): 1.5kΩ in series with 100pF; Machine Model (MM): 0Ω in series with 200pF.
 (3) Quiescent current will increase substantially above 5.5 volts, but is very low in the normal range below 5.5 volts.

TEMPERATURE RANGE

Operating Junction	–40°C to +85°C
Storage Temperature Range	–65°C to +150°C

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, all limits specified for T_J = 25°C. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V _{DET}	Detector Threshold	V _{IN} Falling	2.85	3.0	3.15	V
V _{HYS}	Detector Voltage Hysteresis	V _{IN} Rising	0.095	0.155	0.215	V
I _{IN}	Input Supply Current	V _{IN} = 2.87V	–	1.0	2.2	μA
		V _{IN} = 4.7V	–	1.2	3.6	μA
		V _{IN} = 7.0V ⁽¹⁾	–	25	200	μA
V _{IN(MAX)}	Maximum Operating Voltage		–	–	7.0	V
V _{IN(MIN)}	Minimum Operating Voltage ⁽²⁾		–	0.7 1.0	1.1 1.3	V
I _{OUT(LOW)}	Output Current Low	V _{OUT} = 0.05V, V _{IN} = 1.1V V _{OUT} = 0.50V, V _{IN} = 1.5V	0.01 2	0.6 11	–	mA
t _{PDHL}	Output Delay Time Output Transition High to Low C _L = 10pF, R _L = 470kΩ		–	130	200	μsec
ΔV _{DET} /ΔT	Detect Voltage Temperature Coefficient		–	±120	–	PPM/°C

- (1) Quiescent current will increase substantially above 5.5 volts, but is very low in the normal range below 5.5 volts.
 (2) Temperature range specifications is specified by design.

TYPICAL CHARACTERISTICS

($T_A = 25^\circ\text{C}$, $R_L = 470\text{ k}\Omega$ and $C_L = 10\text{ pF}$ unless otherwise noted).

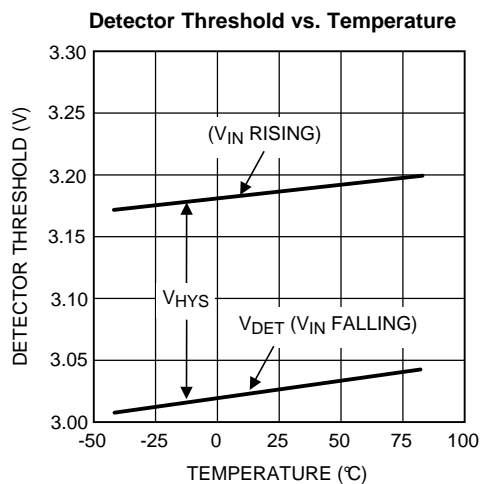


Figure 2.

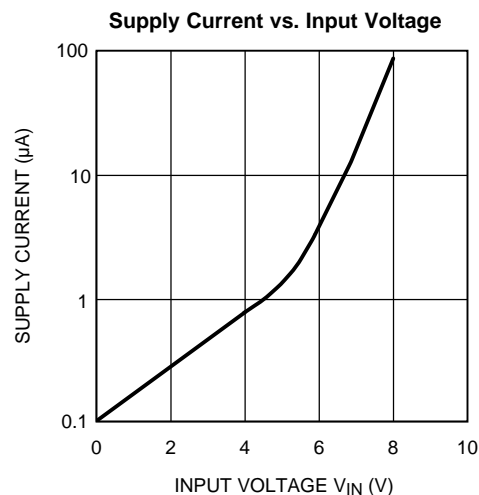


Figure 3.

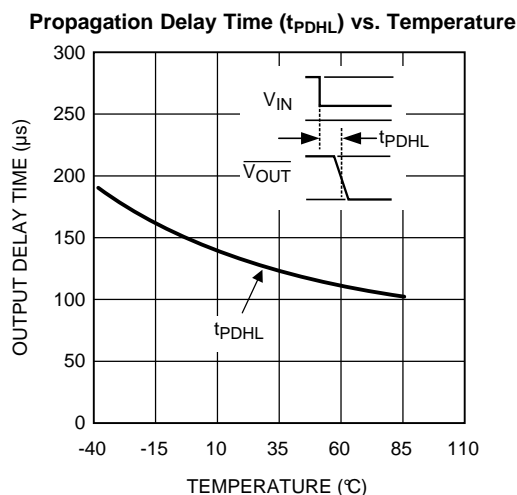


Figure 4.

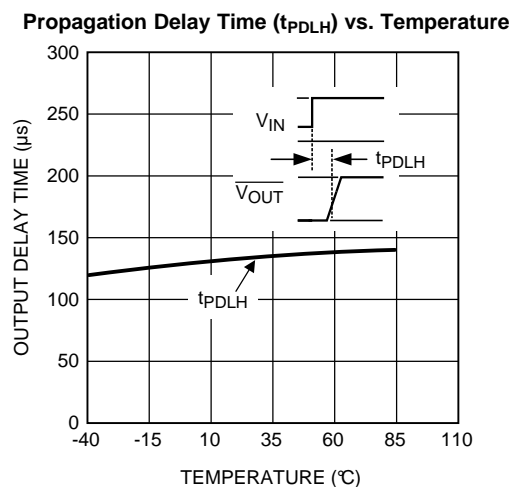


Figure 5.

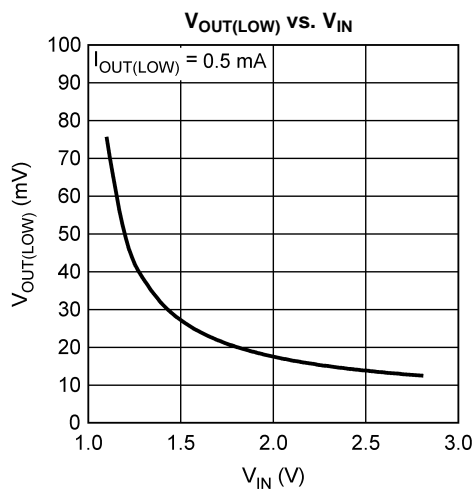


Figure 6.

APPLICATION CIRCUIT INFORMATION

The LMS33460 is a micro power under voltage sensing circuit with an open drain output configuration, which requires a pull resistor.

The LMS33460 features a voltage reference, a comparator with precise thresholds and built in hysteresis to prevent erratic reset operation.

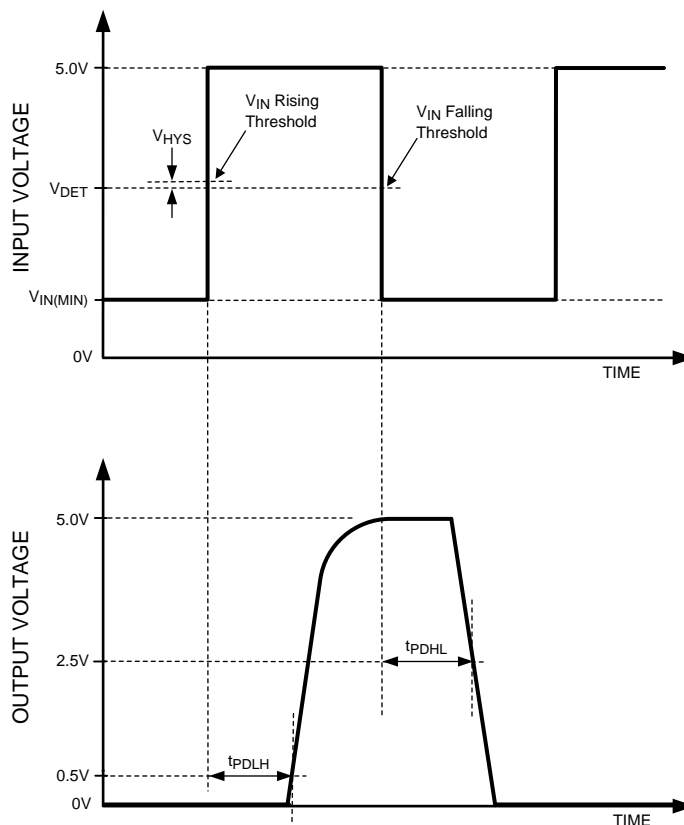


Figure 7. Propagation Delay Timing Diagram

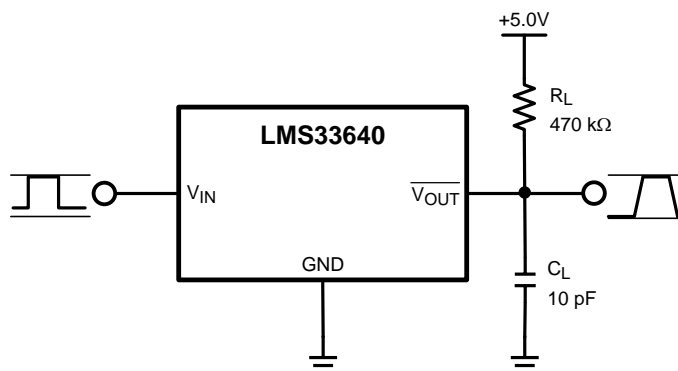


Figure 8. Propagation Delay Test Circuit

REVISION HISTORY

Changes from Revision C (April 2013) to Revision D	Page
• Changed layout of National Data Sheet to TI format	5

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LMS33460MG	NRND	SC70	DCK	5	1000	TBD	Call TI	Call TI	-40 to 85	C33	
LMS33460MG/NOPB	ACTIVE	SC70	DCK	5	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	C33	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION


*All dimensions are nominal

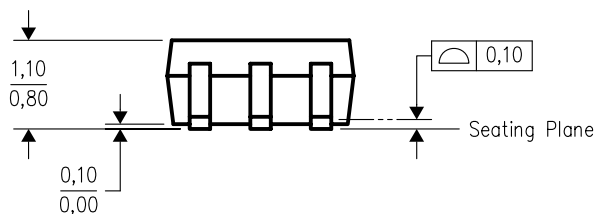
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMS33460MG	SC70	DCK	5	1000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
LMS33460MG/NOPB	SC70	DCK	5	1000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMS33460MG	SC70	DCK	5	1000	210.0	185.0	35.0
LMS33460MG/NOPB	SC70	DCK	5	1000	210.0	185.0	35.0



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